

## Product Summary

$V_{RRM}$ (V)	$I_O$ (A)	$V_{F(TYP)}$ @ 1A (V)	$I_{R(TYP)}$ @ $V_R=30V$ ( $\mu A$ )
40	1	0.425	50

## Features and Benefits

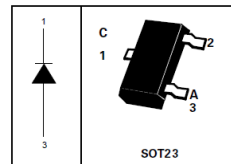
- High current capability ( $I_F = 1A$ )
- Low  $V_F$
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- **Qualified to AEC-Q101 Standards for High Reliability**

## Description and Applications

- DC – DC Converters
- Mobile Telecomms
- PCMA & SCS1

## Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.0089 grams (approximate)



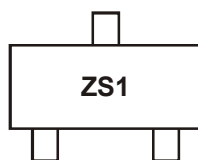
Top View

## Ordering Information (Note 4)

Device	Packaging	Shipping
ZHCS1000TA	SOT23	3000/Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
  2. See [http://www.diodes.com/quality/lead\\_free.html](http://www.diodes.com/quality/lead_free.html) for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

## Marking Information



ZS1 = Product Type Marking Code

**Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units
Continuous Reverse Voltage	V <sub>R</sub>	40	V
Continuous Forward Current	I <sub>F</sub>	1	A
Forward Voltage @ I <sub>F</sub> = 1A (typ)	V <sub>F</sub>	425	mV
Average Peak Forward Current; D.C. = 50%	I <sub>FAV</sub>	1750	mA
Non Repetitive Forward Current	I <sub>FSM</sub>	t ≤ 100μs	12
		t ≤ 10ms	5.2

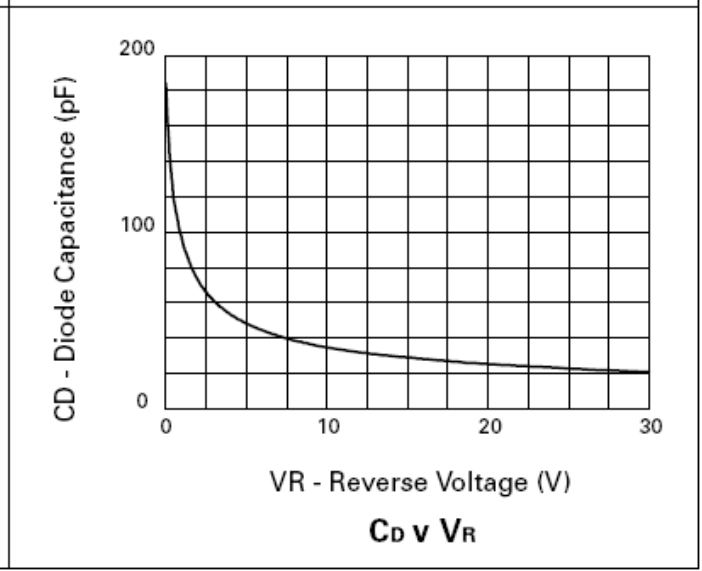
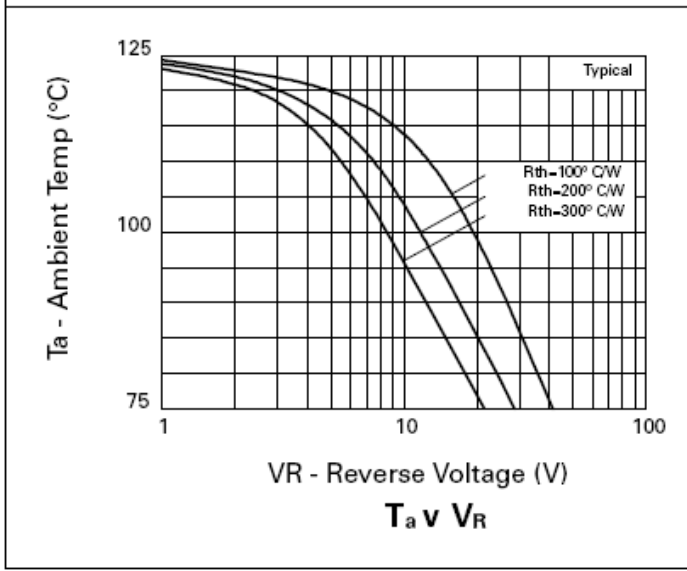
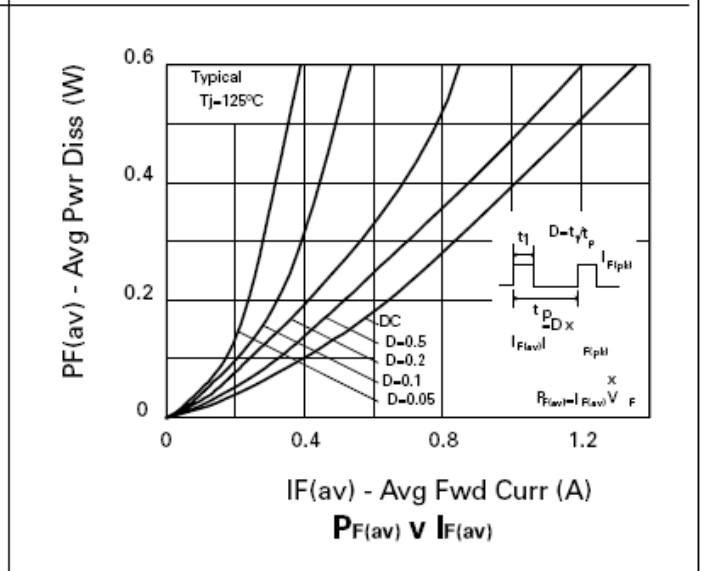
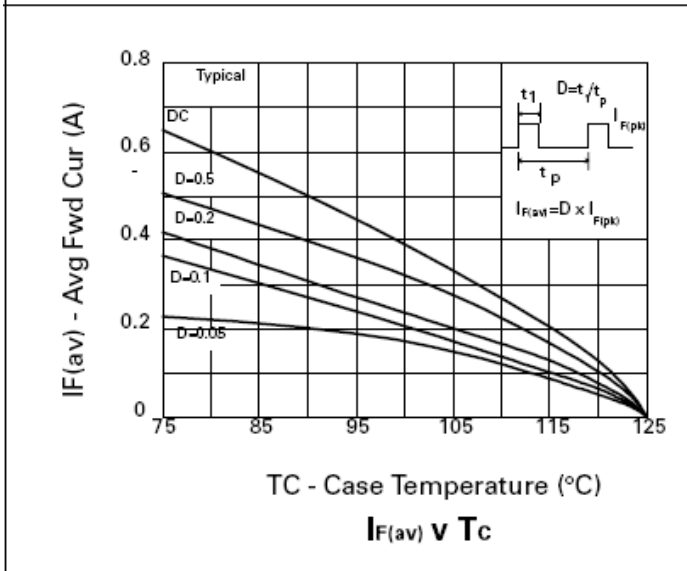
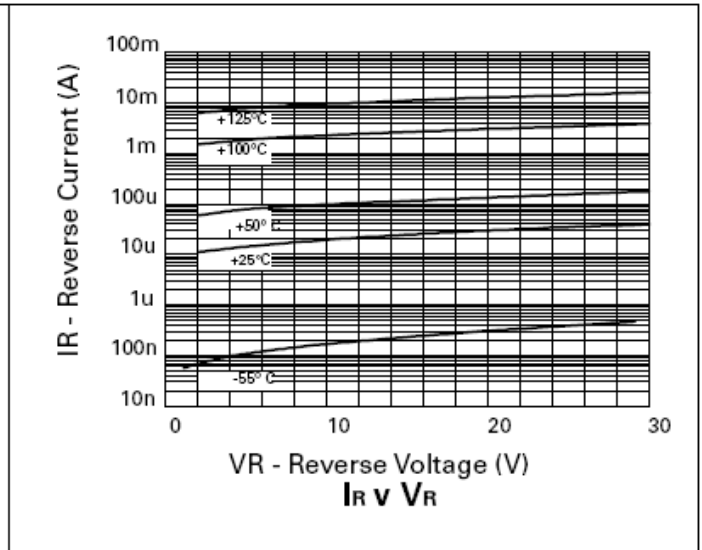
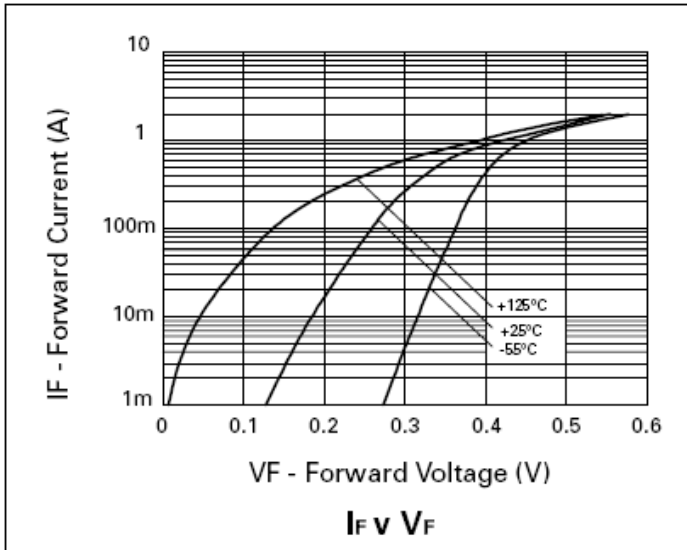
**Thermal Characteristics**

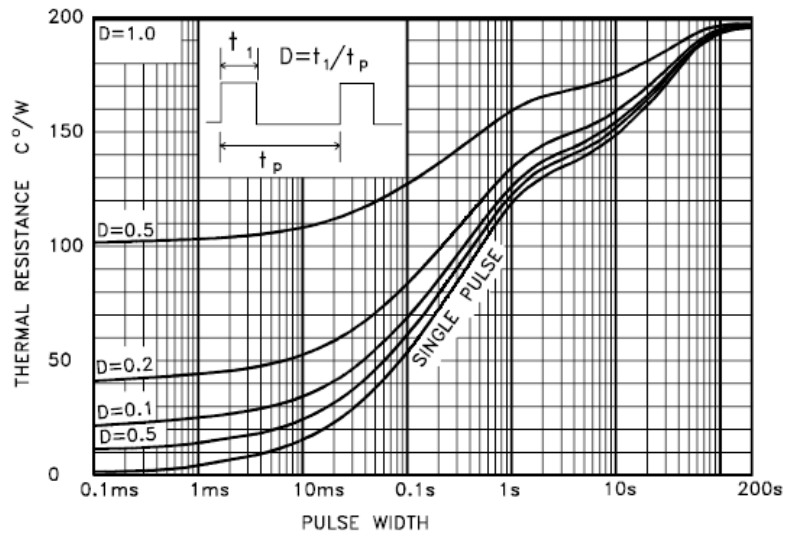
Characteristic	Symbol	Value	Unit
Power Dissipation, T <sub>A</sub> = +25°C	P <sub>D</sub>	500	mW
Junction Temperature	T <sub>J</sub>	+125	°C
Storage Temperature Range	T <sub>STG</sub>	-55 to +150	°C

**Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage	V <sub>(BR)R</sub>	40	60	—	V	I <sub>R</sub> = 300μA
Forward Voltage (Note 5)	V <sub>F</sub>	—	240	270	mV	I <sub>F</sub> = 50mA
		—	265	290		I <sub>F</sub> = 100mA
		—	305	340		I <sub>F</sub> = 250mA
		—	355	400		I <sub>F</sub> = 500mA
		—	390	450		I <sub>F</sub> = 750mA
		—	425	500		I <sub>F</sub> = 1A
		—	495	600		I <sub>F</sub> = 1.5A
		—	420	—		I <sub>F</sub> = 1A, T <sub>A</sub> = +100°C
Reverse Current (Note 6)	I <sub>R</sub>	—	50	100	μA	V <sub>R</sub> = 30V
Total Capacitance	C <sub>T</sub>	—	25	—	pF	f = 1MHz, V <sub>R</sub> = 30V
Reverse Recovery Time	trr	—	12	—	ns	Switched from I <sub>F</sub> = 500mA to I <sub>R</sub> = 500mA Measured @ I <sub>R</sub> = 50mA

Notes: 5. Measured under pulsed conditions. Pulse width = 300μs.  
6. Short duration pulse test used to minimize self-heating effect.



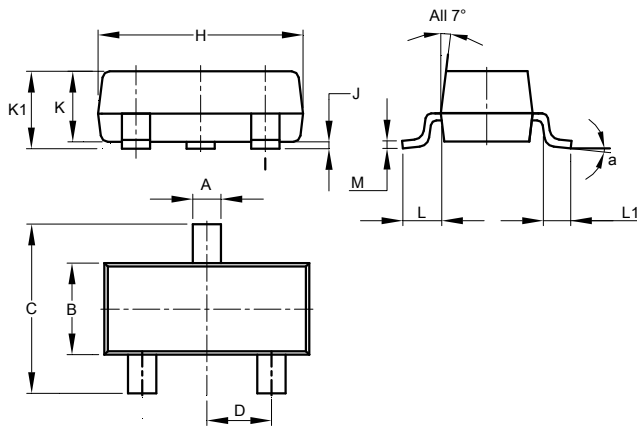


MAXIMUM TRANSIENT THERMAL RESISTANCE\*

\* Devices were mounted on a 15mmx15mm ceramic substrate.

**Package Outline Dimensions**

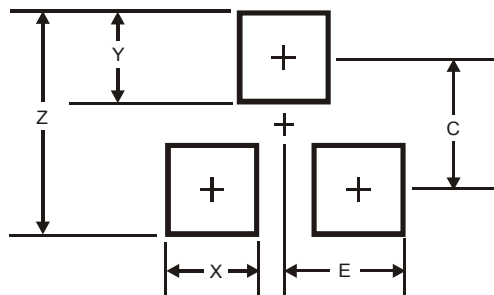
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.



SOT23			
Dim	Min	Max	Typ
A	0.37	0.51	0.40
B	1.20	1.40	1.30
C	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
H	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.890	1.00	0.975
K1	0.903	1.10	1.025
L	0.45	0.61	0.55
L1	0.25	0.55	0.40
M	0.085	0.150	0.110
a	8°		
All Dimensions in mm			

**Suggested Pad Layout**

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
Z	2.9
X	0.8
Y	0.9
C	2.0
E	1.35

**IMPORTANT NOTICE**

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

**LIFE SUPPORT**

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

A. Life support devices or systems are devices or systems which:

1. are intended to implant into the body, or
2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.

B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2013, Diodes Incorporated

**[www.diodes.com](http://www.diodes.com)**